Electronic Patent Application Fee Transmittal								
Application Number:	10801208							
Filing Date:	16-Mar-2004							
Title of Invention:	Methods of manufacturing semiconductor devices having a ruthenium layer via automatic layer deposition							
First Named Inventor/Applicant Name:	Kwang-hee Lee							
Filer:	D. Randal Ayers/Michele McMahan							
Attorney Docket Number:	5649-1277							
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Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
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Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
	Tot	180		